# 74AUP1G885

# Low-power dual function gate

Rev. 11 — 22 July 2019

**Product data sheet** 

## 1. General description

The 74AUP1G885 provides two functions in one device. The output state of the outputs (1Y, 2Y) is determined by the inputs (A, B and C). The output 1Y provides the Boolean function:  $1Y = A \times C$ . The output 2Y provides the Boolean function:  $2Y = \overline{A} \times B + A \times \overline{C}$ .

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire  $V_{CC}$  range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- · High noise immunity
- · Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; I<sub>CC</sub> = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Low-power dual function gate

# 3. Ordering information

**Table 1. Ordering information** 

Type number	Package									
	Temperature range	Name	Description	Version						
74AUP1G885DC	-40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1						
74AUP1G885GT	-40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm	SOT833-1						
74AUP1G885GF	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1 × 0.5 mm	SOT1089						
74AUP1G885GN	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm	SOT1116						
74AUP1G885GS	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm	SOT1203						

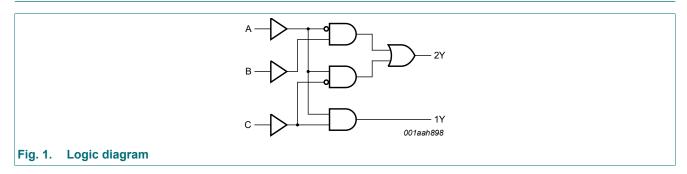
# 4. Marking

Table 2. Marking codes

Tubic 2. Marking codes						
Type number	Marking code [1]					
74AUP1G885DC	pS8					
74AUP1G885GT	pS8					
74AUP1G885GF	58					
74AUP1G885GN	58					
74AUP1G885GS	58					

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

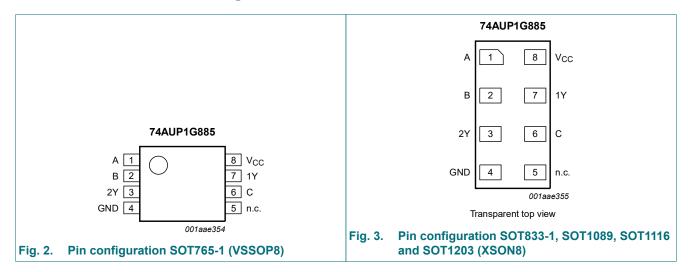
# 5. Functional diagram



Low-power dual function gate

# 6. Pinning information

### 6.1. Pinning



### 6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
A, B, C	1, 2, 6	data input
GND	4	ground (0 V)
n.c.	5	not connected
1Y, 2Y	7, 3	data output
V <sub>CC</sub>	8	supply voltage

# 7. Functional description

#### **Table 4. Function table**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level.$ 

Input		Output		
Α	В	С	1Y	2Y
L	L	L	L	L
Н	L	L	L	Н
L	Н	L	L	Н
Н	Н	L	L	Н
L	L	Н	L	L
Н	L	Н	Н	L
L	Н	Н	L	Н
Н	Н	Н	Н	L

Low-power dual function gate

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage	[1]	-0.5	+4.6	V
lok	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode [1]	-0.5	+4.6	V
Io	output current	V <sub>O</sub> = 0 V to V <sub>CC</sub>	-	±20	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C [2]	-	250	mW

<sup>[1]</sup> The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT833-1 (XSON8) packages: Ptot derates linearly with 3.1 mW/K above 68 °C.

For SOT1089 (XSON8) packages: Ptot derates linearly with 4.0 mW/K above 88 °C.

For SOT1116 (XSON8) packages: Ptot derates linearly with 4.2 mW/K above 90 °C.

For SOT1203 (XSON8) packages:  $P_{tot}$  derates linearly with 3.6 mW/K above 81 °C.

## 9. Recommended operating conditions

#### **Table 6. Operating conditions**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode	0	V <sub>CC</sub>	V
		Power-down mode; V <sub>CC</sub> = 0 V	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 0.8 V to 3.6 V	-	200	ns/V

<sup>[2]</sup> For SOT765-1 (VSSOP8) packages: Ptot derates linearly with 4.9 mW/K above 99 °C.

Low-power dual function gate

## 10. Static characteristics

#### **Table 7. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	25 °C				'	
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 0.8 V	0.70V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	0.65V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	-	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 0.8 V	-	-	0.30V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.35V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V
$V_{OH}$	HIGH-level output	$V_I = V_{IH}$ or $V_{IL}$				
	voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.75V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	1.11	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.32	-	-	V
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	2.05	-	-	V
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.9	-	-	V
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.72	-	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.6	-	-	V
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.3V <sub>CC</sub>	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.31	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.31	V
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.31	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.44	V
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.31	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.44	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = GND to 3.6 V; V <sub>CC</sub> = 0 V to 3.6 V	-	-	±0.1	μA
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.2	μA
Δl <sub>OFF</sub>	additional power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.2	μA
I <sub>CC</sub>	supply current	$V_I$ = GND or $V_{CC}$ ; $I_O$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.5	μA
ΔI <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$ [1]	-	-	40	μA
Cı	input capacitance	$V_{CC}$ = 0 V to 3.6 V; $V_I$ = GND or $V_{CC}$	-	0.6	-	pF
Co	output capacitance	V <sub>O</sub> = GND; V <sub>CC</sub> = 0 V	-	1.3	-	pF

## Low-power dual function gate

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	40 °C to +85 °C		ı			
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 0.8 V	0.70V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	0.65V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 0.8 V	-	-	0.30V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.35V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V
V <sub>OH</sub>	HIGH-level output	$V_I = V_{IH}$ or $V_{IL}$				
	voltage	$I_{O}$ = -20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.7V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	1.03	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.30	-	-	V
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	1.97	-	-	V
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.85	-	-	V
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.67	-	-	V
		$I_{O}$ = -4.0 mA; $V_{CC}$ = 3.0 V	2.55	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O}$ = 20 $\mu$ A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.1	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.3V <sub>CC</sub>	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.37	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.35	V
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.33	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.45	V
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.33	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.45	V
l <sub>l</sub>	input leakage current	$V_{I}$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V	-	-	±0.5	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{I}$ or $V_{O}$ = 0 V to 3.6 V; $V_{CC}$ = 0 V	-	-	±0.5	μΑ
ΔI <sub>OFF</sub>	additional power-off leakage current	$V_1$ or $V_0 = 0 V$ to 3.6 V; $V_{CC} = 0 V$ to 0.2 V	-	-	±0.6	μΑ
I <sub>CC</sub>	supply current	$V_I$ = GND or $V_{CC}$ ; $I_O$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	0.9	μA
ΔI <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$ [1]	-	-	50	μA

6 / 18

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	40 °C to +125 °C				-	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 0.8 V	0.75V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	0.70V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 0.8 V	-	-	0.25V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.30V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V
V <sub>OH</sub>	HIGH-level output	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
	voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.11	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.6V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	0.93	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.17	-	-	V
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	1.77	-	-	V
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.67	-	-	V
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.40	-	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.30	-	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.11	V
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.33V <sub>CC</sub>	V
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.41	V
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.39	V
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.36	V
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.50	V
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.36	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.50	V
l <sub>l</sub>	input leakage current	$V_{I}$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V	-	-	±0.75	μA
I <sub>OFF</sub>	power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V	-	-	±0.75	μA
ΔI <sub>OFF</sub>	additional power-off leakage current	$V_{I}$ or $V_{O}$ = 0 V to 3.6 V; $V_{CC}$ = 0 V to 0.2 V	-	-	±0.75	μΑ
I <sub>CC</sub>	supply current	$V_I$ = GND or $V_{CC}$ ; $I_O$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V	-	-	1.4	μA
ΔI <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$ [1]	-	-	75	μΑ

<sup>[1]</sup> One input at  $V_{CC}$  - 0.6 V, other inputs at  $V_{CC}$  or GND.

Low-power dual function gate

# 11. Dynamic characteristics

### **Table 8. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V; for test circuit see Fig. 5.

Symbol	Parameter	arameter Conditions		25 °C		-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	
C <sub>L</sub> = 5 p	F									
t <sub>pd</sub>	propagation	A, C to 1Y; see <u>Fig. 4</u> [2]								
	delay	V <sub>CC</sub> = 0.8 V	-	17.3	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	1.1	5.2	9.7	0.9	12.8	0.9	14.2	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.2	3.7	5.9	1.0	7.8	1.0	8.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.1	3.0	4.8	0.9	6.2	0.9	6.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.1	2.4	3.6	1.0	4.1	1.0	4.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.1	2.1	3.1	1.0	3.6	1.0	4.1	ns
		A, B to 2Y; see <u>Fig. 4</u> [2]								
		V <sub>CC</sub> = 0.8 V	-	21.5	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	1.7	6.0	12.7	1.4	12.8	1.4	14.2	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.7	4.2	7.2	1.4	7.8	1.4	8.7	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.4	3.3	5.8	1.2	6.5	1.2	7.2	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.2	2.6	4.1	1.0	4.7	1.0	5.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.1	2.3	3.5	0.9	3.8	0.9	4.2	ns
C <sub>L</sub> = 10	pF									
t <sub>pd</sub>	propagation	A, C to 1Y; see <u>Fig. 4</u> [2]								
	delay	V <sub>CC</sub> = 0.8 V	-	20.8	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	1.2	6.1	11.4	1.2	14.6	1.2	16.1	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.4	4.3	7.2	1.2	8.7	1.2	9.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.4	3.6	5.7	1.3	6.8	1.3	7.5	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.4	2.9	4.2	1.2	4.8	1.2	5.4	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.4	2.7	3.9	1.3	4.1	1.3	4.6	ns
		A, B to 2Y; see <u>Fig. 4</u> [2]								
		V <sub>CC</sub> = 0.8 V	-	25.0	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	1.8	6.9	14.4	1.7	14.6	1.7	16.1	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.9	4.8	8.5	1.5	9.1	1.5	10.1	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.9	3.9	6.6	1.7	7.2	1.7	8.0	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.5	3.1	4.7	1.3	5.4	1.3	5.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.4	2.8	4.3	1.3	4.6	1.3	5.1	ns

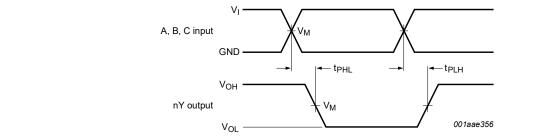
Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Typ [1]	Max	Min	Max	Min	Max	
C <sub>L</sub> = 15	pF					•				
t <sub>pd</sub>	propagation	A, C to 1Y; see <u>Fig. 4</u> [2]								
	delay	V <sub>CC</sub> = 0.8 V	_	24.3	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	1.3	6.9	13.0	1.2	16.2	1.2	17.9	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.7	4.9	8.0	1.4	9.7	1.4	10.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.5	4.1	6.4	1.4	7.6	1.4	8.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	3.4	5.0	1.6	5.4	1.6	6.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.7	3.1	4.4	1.6	4.7	1.6	5.3	ns
		A, B to 2Y; see <u>Fig. 4</u> [2]								
		V <sub>CC</sub> = 0.8 V	-	28.5	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.1	7.7	16.0	1.9	16.3	1.9	18.0	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.2	5.4	9.4	2.4	10.3	2.4	11.4	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.0	4.4	7.4	1.8	8.2	1.8	9.1	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.8	3.6	5.5	1.6	6.0	1.6	6.7	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.7	3.3	4.8	1.5	5.2	1.5	5.8	ns
C <sub>L</sub> = 30	pF					'	'	•	'	
t <sub>pd</sub>	propagation delay	A, C to 1Y; see <u>Fig. 4</u> [2]								
		V <sub>CC</sub> = 0.8 V	-	34.7	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.4	9.2	17.7	2.3	20.9	2.3	23.0	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.5	6.5	10.6	2.5	12.2	2.5	13.5	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.5	5.4	8.5	2.4	9.4	2.4	10.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.6	4.5	6.4	2.4	7.0	2.4	7.7	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.5	4.2	5.7	2.3	6.6	2.3	7.3	ns
		A, B to 2Y; see <u>Fig. 4</u> [2]								
		V <sub>CC</sub> = 0.8 V	-	38.9	-	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.6	10.0	20.5	2.6	21.5	2.6	23.7	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.6	6.9	11.9	2.6	13.2	2.6	14.5	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.7	5.7	9.5	2.7	10.5	2.7	11.6	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.5	4.7	6.9	2.5	7.6	2.5	8.4	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.4	4.4	6.1	2.4	7.1	2.4	7.9	ns
$C_L = 5 p$	F, 10 pF, 15 pF	and 30 pF						•		·
C <sub>PD</sub>	power	$f_i = 1 \text{ MHz}; V_I = \text{GND to } V_{CC}$ [3]								
	dissipation capacitance	V <sub>CC</sub> = 0.8 V	-	2.7	-	-	-	-	-	pF
	Sapaoitarios	V <sub>CC</sub> = 1.1 V to 1.3 V	-	2.9	-	-	-	-	-	pF
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	3.0	-	-	-	-	-	pF
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	3.1	-	-	-	-	-	pF
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	3.5	-	-	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	4.1	-	-	-	-	-	pF

<sup>[1]</sup> All typical values are measured at nominal  $V_{\mbox{\scriptsize CC}}.$ 

 $t_{pd}$  is the same as  $t_{pLH}$  and  $t_{pHL}$ .  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:  $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz;  $C_L$  = output load capacitance in pF;  $V_{CC}$  = supply voltage in V; N = number of inputs switching;  $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

#### Low-power dual function gate

### 11.1. Waveforms and test circuit



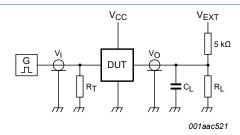
Measurement points are given in Table 9.

Logic levels: V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

Fig. 4. The data input (A, B, C) to output (nY) propagation delays

**Table 9. Measurement points** 

Supply voltage	Output	Input		
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	VI	$t_r = t_f$
0.8 V to 3.6 V	0.5 × V <sub>CC</sub>	0.5 × V <sub>CC</sub>	V <sub>CC</sub>	≤ 3.0 ns



Test data is given in Table 10.

Definitions for test circuit:

R<sub>I</sub> = Load resistance.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig. 5. Test circuit for measuring switching times

#### Table 10. Test data

Supply voltage	Load	V <sub>EXT</sub>			
V <sub>CC</sub>	CL	R <sub>L</sub> [1]	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	2 × V <sub>CC</sub>

[1] For measuring enable and disable times  $R_L$  = 5  $k\Omega.$ 

For measuring propagation delays, set-up and hold times and pulse width  $R_L$  = 1  $M\Omega$ .

Low-power dual function gate

# 12. Package outline

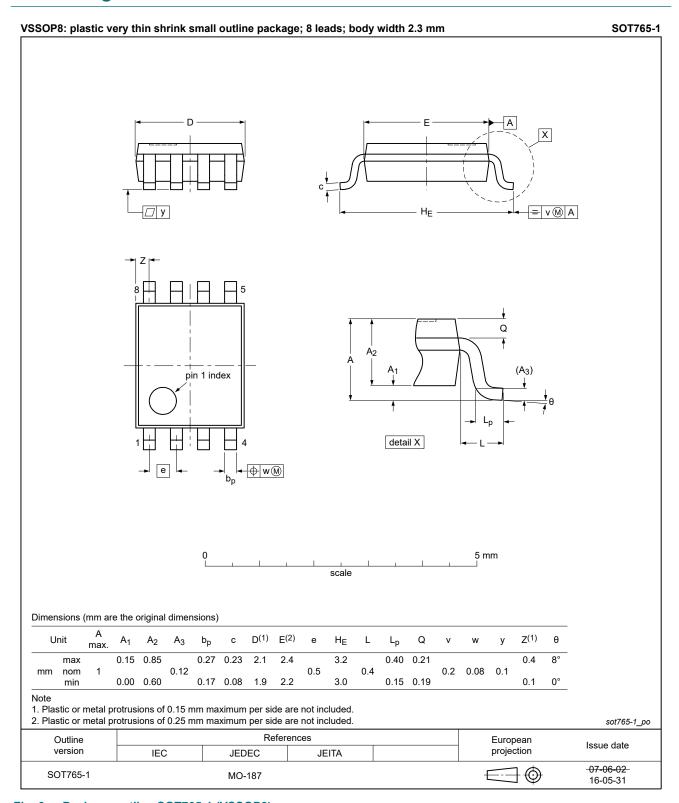


Fig. 6. Package outline SOT765-1 (VSSOP8)

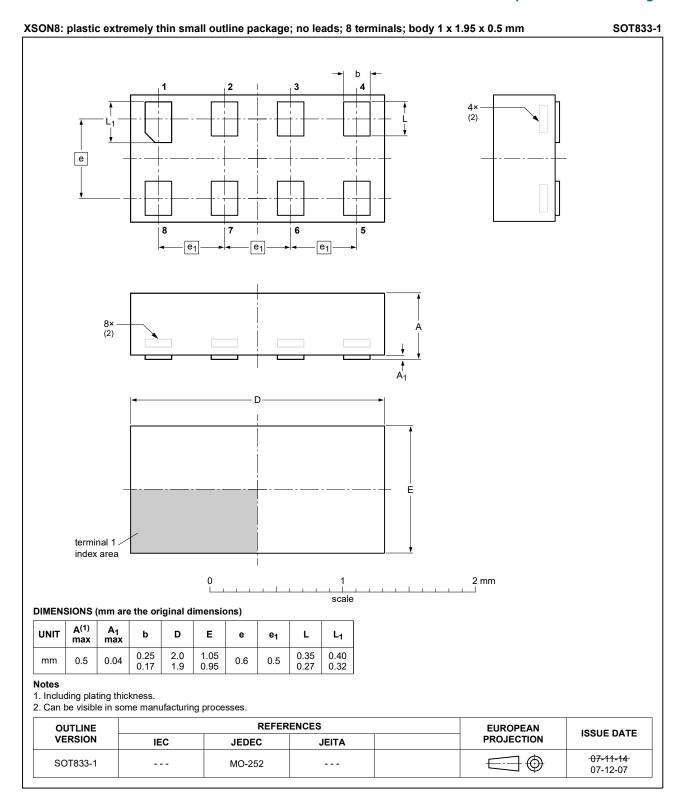


Fig. 7. Package outline SOT833-1 (XSON8)

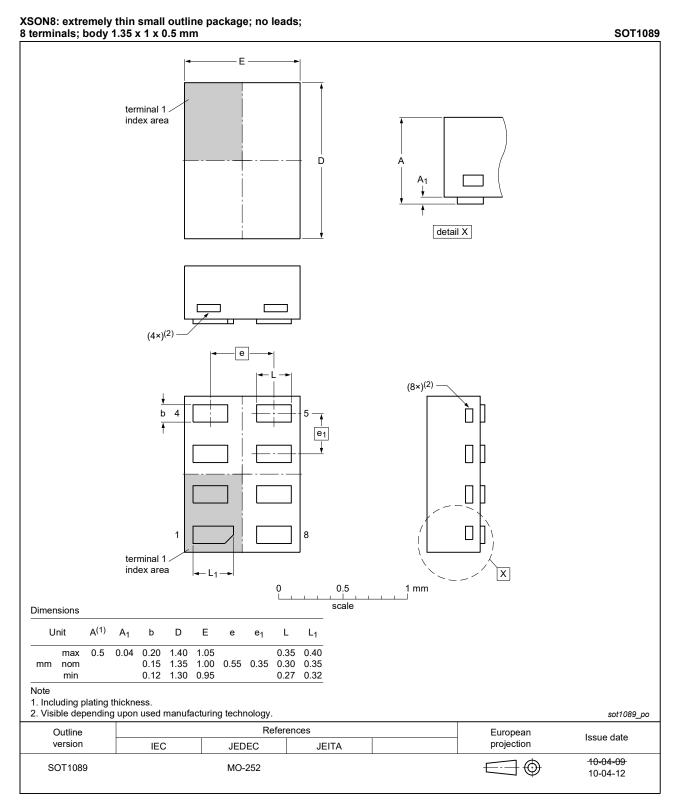


Fig. 8. Package outline SOT1089 (XSON8)

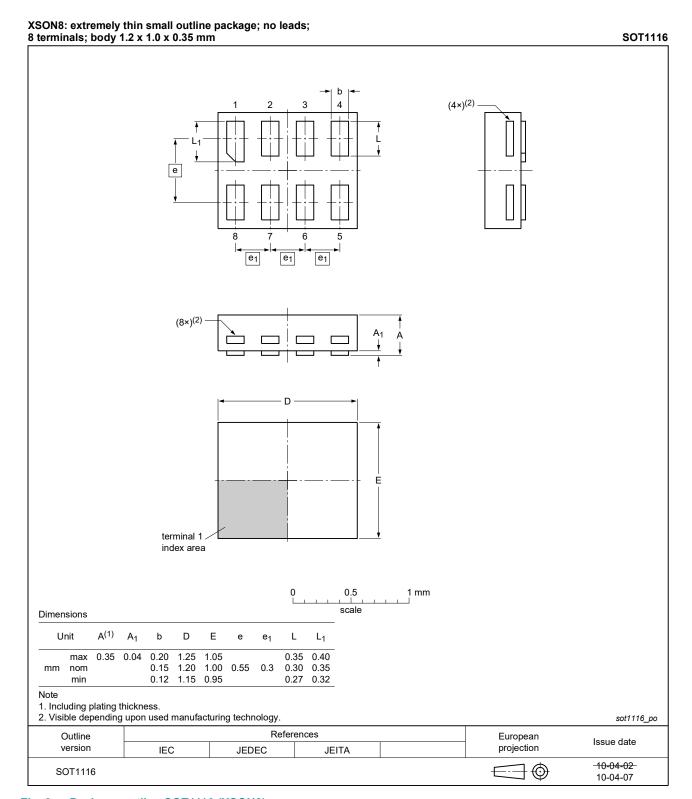


Fig. 9. Package outline SOT1116 (XSON8)

### Low-power dual function gate

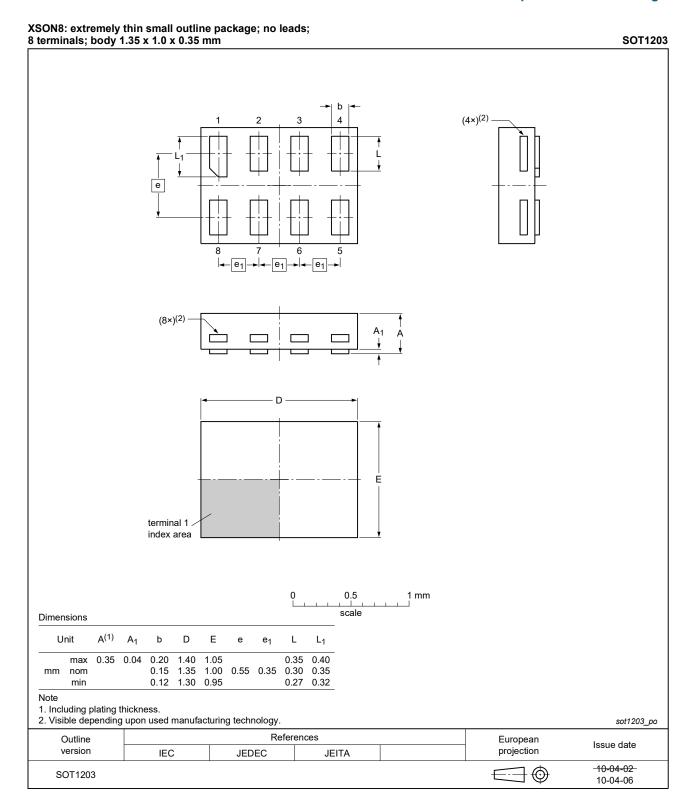


Fig. 10. Package outline SOT1203 (XSON8)

15 / 18

Low-power dual function gate

## 13. Abbreviations

#### **Table 11. Abbreviations**

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

# 14. Revision history

### Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74AUP1G885 v.11	20190722	Product data sheet	-	74AUP1G885 v.10	
Modifications:	<ul> <li>Type number 74AUP1G885GM (SOT902-2) removed.</li> <li>Layout of <u>Table 8</u> Dynamic characteristics updated.</li> </ul>				
74AUP1G885 v.10	20190314	Product data sheet	-	74AUP1G885 v.9	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Type number 74AUP1G885GD (SOT996-2) removed.</li> <li>Package outline drawing SOT765-1 (VSSOP8) updated.</li> <li>Package outline drawing SOT902-2 (XQFN8) updated.</li> </ul>				
74AUP1G885 v.9	20130131	Product data sheet	-	74AUP1G885 v.8	
Modifications:	For type number 74AUP1G885GD XSON8U has changed to XSON8.				
74AUP1G885 v.8	20120608	Product data sheet	-	74AUP1G885 v.7	
74AUP1G885 v.7	20111129	Product data sheet	-	74AUP1G885 v.6	
74AUP1G885 v.6	20101021	Product data sheet	-	74AUP1G885 v.5	
74AUP1G885 v.5	20090626	Product data sheet	-	74AUP1G885 v.4	
74AUP1G885 v.4	20090401	Product data sheet	-	74AUP1G885 v.3	
74AUP1G885 v.3	20080328	Product data sheet	-	74AUP1G885 v.2	
74AUP1G885 v.2	20070710	Product data sheet	-	74AUP1G885 v.1	
74AUP1G885 v.1	20061201	Product data sheet	-	-	

### Low-power dual function gate

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <a href="https://www.nexperia.com">https://www.nexperia.com</a>.

#### **Definitions**

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### **Disclaimers**

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal

injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nexperia.com/profile/terms">http://www.nexperia.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

#### **Trademarks**

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

74AUP1G885

All information provided in this document is subject to legal disclaimers.

Nexperia B.V. 2019. All rights reserved

### Low-power dual function gate

## **Contents**

1. General description	1
2. Features and benefits	1
3. Ordering information	2
4. Marking	2
5. Functional diagram	2
6. Pinning information	3
6.1. Pinning	3
6.2. Pin description	3
7. Functional description	3
8. Limiting values	4
9. Recommended operating conditions	4
10. Static characteristics	5
11. Dynamic characteristics	8
11.1. Waveforms and test circuit	10
12. Package outline	11
13. Abbreviations	16
14. Revision history	16
15. Legal information	17

For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 22 July 2019

<sup>©</sup> Nexperia B.V. 2019. All rights reserved

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

## Nexperia:

<u>74AUP1G885DC,125</u> <u>74AUP1G885GM,125</u> <u>74AUP1G885GT,115</u> <u>74AUP1G885GF,115</u> <u>74AUP1G885GN,115</u> 74AUP1G885GS,115